

# PMT21EN-VB Datasheet N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY	
V <sub>DS</sub> (V)	30
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.019
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.021
I <sub>D</sub> (A)	7
Configuration	Single

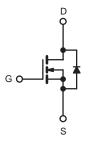
#### **FEATURES**

- Trench Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested









N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>C</sub> = 25 °C, unles	s otherwise noted	d)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		$V_{DS}$	30	V
Gate-Source Voltage		$V_{GS}$	± 20	V
	T <sub>C</sub> = 25 °C	ı	7	
Continuous Drain Current	T <sub>C</sub> = 125 °C	I <sub>D</sub>	4.5	
Continuous Source Current (Diode Conduction)		I <sub>S</sub>	5	А
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	31	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	10	
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	5	mJ
Mariana Damar Dissipation?	T <sub>C</sub> = 25 °C	25 °C	4	\\\
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 125 °C	$P_{D}$	1.3	W
Operating Junction and Storage Temperature	re Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount <sup>b</sup>	$R_{thJA}$	110	°C/W	
Junction-to-Foot (Drain)		$R_{thJF}$	38	C/VV	

#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. When mounted on 1" square PCB (FR-4 material).
- c. Parametric verification ongoing.

服务热线:400-655-8788

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<b>SPECIFICATIONS</b> ( $T_C = 25  ^{\circ}C$ , PARAMETER	SYMBOL	TEC	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	STIVIBOL	TEST CONDITIONS		IVIIIN.	ITF.	WAX.	ONII
	V <sub>DS</sub>	V	= 0 V, I <sub>D</sub> = 250 μA	30	_		<u> </u>
Drain-Source Breakdown Voltage		46 . 5 .		0.5		-	V
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$ $V_{DS} = 0 V, V_{GS} = \pm 20 V$			-	1.5	^
Gate-Source Leakage	I <sub>GSS</sub>		1	-	-	± 100	nA
Zero Gate Voltage Drain Current		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 30 V	-	-	1	μΑ
	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 30 V, T <sub>J</sub> = 125 °C	-	-	50	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 30 V, T <sub>J</sub> = 175 °C	-	-	150	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	V <sub>DS</sub> ≥ 5 V	10	-	-	Α
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 6 A	-	0.019	-	- Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}$	I <sub>D</sub> = 4.9 A	-	0.021	ı	
Drain Gource on Gtate Nesistance	1 103(011)	$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 6 A, T <sub>J</sub> = 125 °C	-	0.054	-	
		$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 6 A, T <sub>J</sub> = 175 °C	-	0.064	ı	
Forward Transconductance <sup>b</sup>	9fs	$V_{DS}$	$= 15 \text{ V}, I_D = 5 \text{ A}$	=	21	ı	S
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			-	295	-	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	$V_{DS} = 15 \text{ V}, f = 1 \text{ MHz}$	-	67	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			-	25	-	]
Total Gate Charge <sup>c</sup>	Qg			-	6	-	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{DS} = 15 \text{ V}, I_{D} = 6 \text{ A}$	-	1.2	1	nC
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>	1		-	1	1	
Gate Resistance	$R_g$	f = 1 MHz		3.0	6.65	11	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>				6	9	
Rise Time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub> =	$V_{DD} = 15 \text{ V}, R_{I} = 2.5 \Omega$		12	18	1 '
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>		$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	=	13	20	ns
Fall Time <sup>c</sup>	t <sub>f</sub>	1		=	8	12	1
Source-Drain Diode Ratings and Char	acteristics <sup>b</sup>						
Pulsed Current <sup>a</sup>	I <sub>SM</sub>	T		-	-	31	Α
Forward Voltage	V <sub>SD</sub>	le =	= 3 A, V <sub>GS</sub> = 0 V	-	0.8	1.1	V

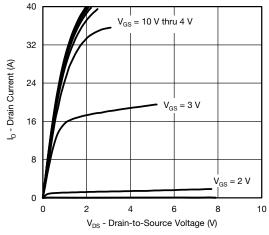
#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

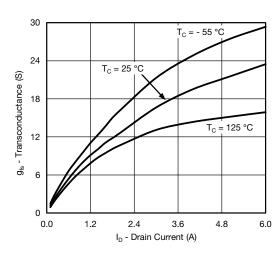
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



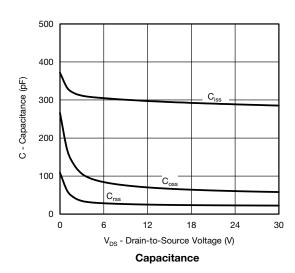
## **TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)

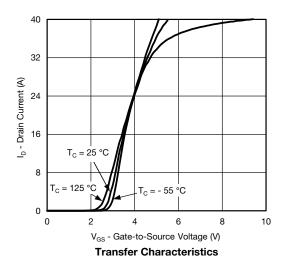






#### Transconductance

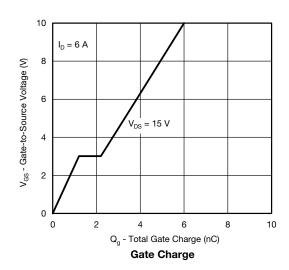




0.10 0.08 0.06 0.06 0.04 0.02 0.00 

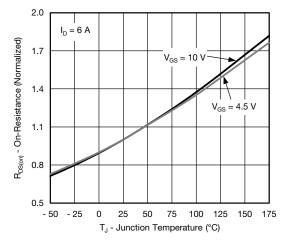
I<sub>D</sub> - Drain Current (A)

On-Resistance vs. Drain Current

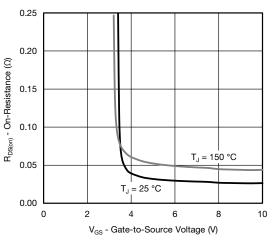




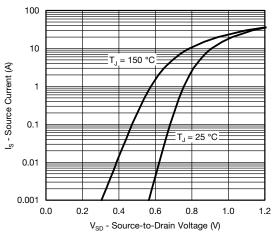
## **TYPICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise noted)



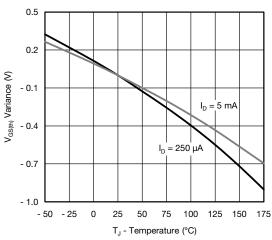
On-Resistance vs. Junction Temperature



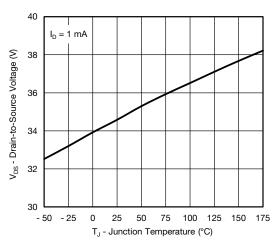
On-Resistance vs. Gate-to-Source Voltage



Source-Drain Diode Forward Voltage



Threshold Voltage

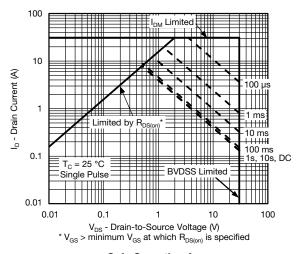


Drain Source Breakdown vs. Junction Temperature

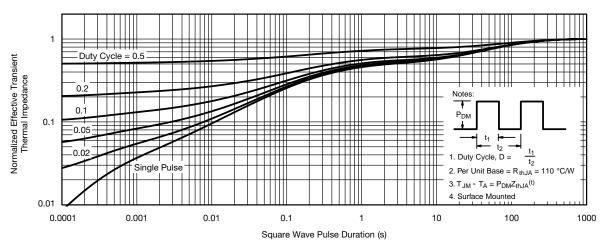


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## **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)



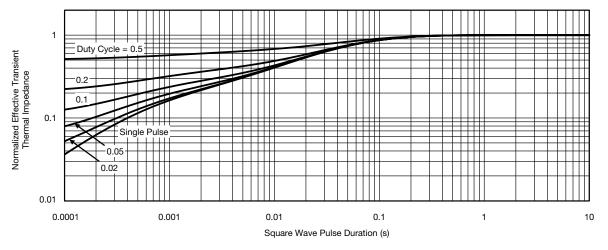
#### Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Foot

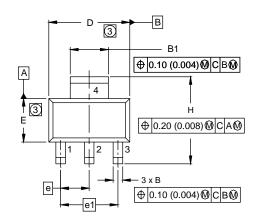
#### Note

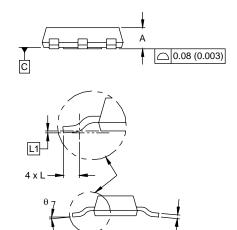
- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Foot (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities

can widely vary depending on actual application parameters and operating conditions.



## **SOT-223 (HIGH VOLTAGE)**





DIM.	MILLI	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
Е	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905 BSC		
e1	4.60 BSC		0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L,	0.91	-	0.036	-	
L1	0.061 BSC		0.0024	4 BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

#### Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.



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